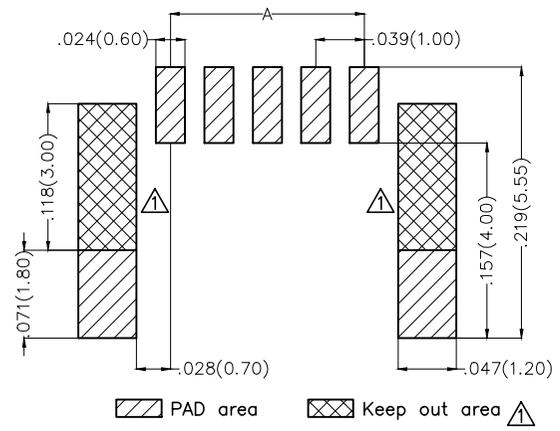
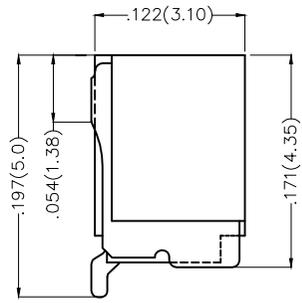
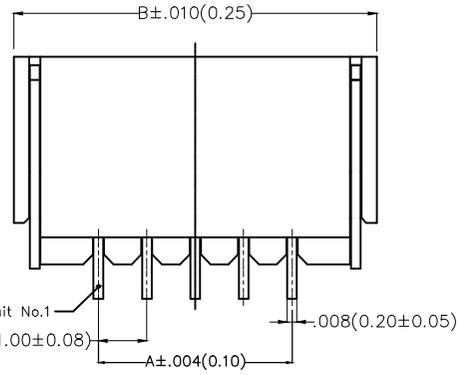
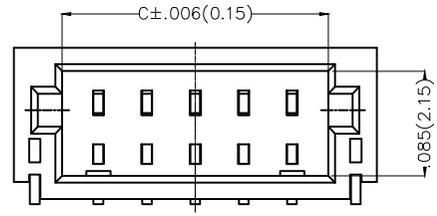


1 2 3 4 5 6 7 8

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD
1	△1	Add Keep out area	08/JAN/20	KATE	CHERRY
2	△2	Change the packaging specification	17/NOV/20	KATE	CHERRY
3	△3	Corrected the terminal material	29/OCT/21	KATE	CHERRY



Electrical

Current Rating: 1A AC(rms)/DC
 Voltage Rating: 50V AC(rms)/DC
 Contact Resistance: 20 mΩ Max
 Insulation Resistance: 100 MΩ MIN
 Withstanding Voltage: 500V AC r.m.s
 Temperature Range-Operating: -25°C ~ +85°C

Material and Plating

Housing: PA9T(UL 94V-0)

- △ Contact Pin: Phosphor bronze/ Tin plated
- Solder Tab: Copper alloy/ Tin plated

Ordering Information

FWF 100 01 - S XX B 2 4 W5 M
 1 2 3 4 5 6 7 8 9 10

1	Category FWF-Wafer	2	Series Number 100-Pitch1.0mm	3	Distinction No. 01	4	Row Option Single Row	5	Circuits XX	6	Entry Angle B-90° Angle
7	Plating 2-Tin Plated	8	Material-Resin 4-PA9T	9	Color-Resin W5-White	10	Packaging M-Reel				

THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY FRANK	DATE 28/JUN/13	PART NO. FWF10001-SXXB24W5M	ITEM NO. FWF10001	 Leader Of Industry
	DESIGN UNITS Inch (metric)	X.±.012(0.30) X.X±.008(0.20) X.XX±.006(0.15) X.XXX±.004(0.10)	X.±5° .X'±2' .XX'±1" .XXX'±0.5'	CHECKED BY JACOB	DATE 28/JUN/13	TITLE Wire to Board (Wafer) Pitch 1.0mm 90° Angle (SMT)	
SCALE 5:1	SIZE A4	DRAWN BY CHERRY		DATE 28/JUN/13	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		

1 2 3 4 5 6 7 8

1 2 3 4 5 6 7 8

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

A

B

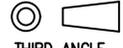
C

D

E

F

Circuits (n)	Part No.	Dimensions(in/mm)			Circuits (n)	Part No.	Dimensions(in/mm)		
		A	B	C			A	B	C
2	FWF10001-S02B24W5M	.039(1.00)	.177(4.50)	.102(2.60)	11	FWF10001-S11B24W5M	.394(10.00)	.531(13.50)	.457(11.60)
3	FWF10001-S03B24W5M	.078(2.00)	.217(5.50)	.142(3.60)	12	FWF10001-S12B24W5M	.433(11.00)	.571(14.50)	.496(12.60)
4	FWF10001-S04B24W5M	.118(3.00)	.256(6.50)	.181(4.60)	13	FWF10001-S13B24W5M	.472(12.00)	.610(15.50)	.535(13.60)
5	FWF10001-S05B24W5M	.157(4.00)	.295(7.50)	.220(5.60)	14	FWF10001-S14B24W5M	.512(13.00)	.650(16.50)	.575(14.60)
6	FWF10001-S06B24W5M	.197(5.00)	.335(8.50)	.260(6.60)	15	FWF10001-S15B24W5M	.551(14.00)	.689(17.50)	.614(15.60)
7	FWF10001-S07B24W5M	.236(6.00)	.374(9.50)	.299(7.60)	16	FWF10001-S16B24W5M	.591(15.00)	.728(18.50)	.654(16.60)
8	FWF10001-S08B24W5M	.276(7.00)	.413(10.50)	.339(8.60)	17	FWF10001-S17B24W5M	.630(16.00)	.768(19.50)	.693(17.60)
9	FWF10001-S09B24W5M	.315(8.00)	.453(11.50)	.378(9.60)	18	FWF10001-S18B24W5M	.669(17.00)	.807(20.50)	.732(18.60)
10	FWF10001-S10B24W5M	.354(9.00)	.492(12.50)	.417(10.60)	20	FWF10001-S20B24W5M	.748(19.00)	.886(22.50)	.811(20.60)

 THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY	DATE	PART NO.	ITEM NO.	 Leader Of Industry	
	X.±.012(0.30)	X.±5'	FRANK	28/JUN/13	FWF10001-SXXB24W5M	FWF10001		
	X.X±.008(0.20)	.X'±2'	CHECKED BY	DATE	TITLE	REV 3		SHEET NO. 2/3
	X.XX±.006(0.15)	.XX'±1'	JACOB	28/JUN/13	Wire to Board (Wafer) Pitch 1.0mm 90° Angle (SMT)	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION		
SCALE	SIZE	X.XXX±.004(0.10)	.XXX'±0.5'	DRAWN BY	DATE			
5:1	A4			CHERRY	28/JUN/13			

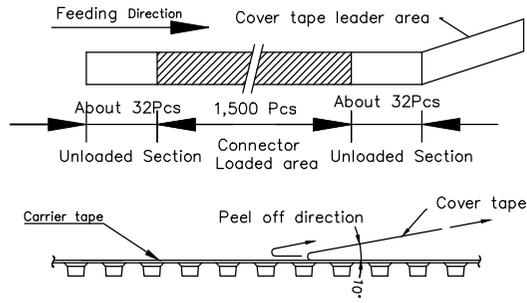
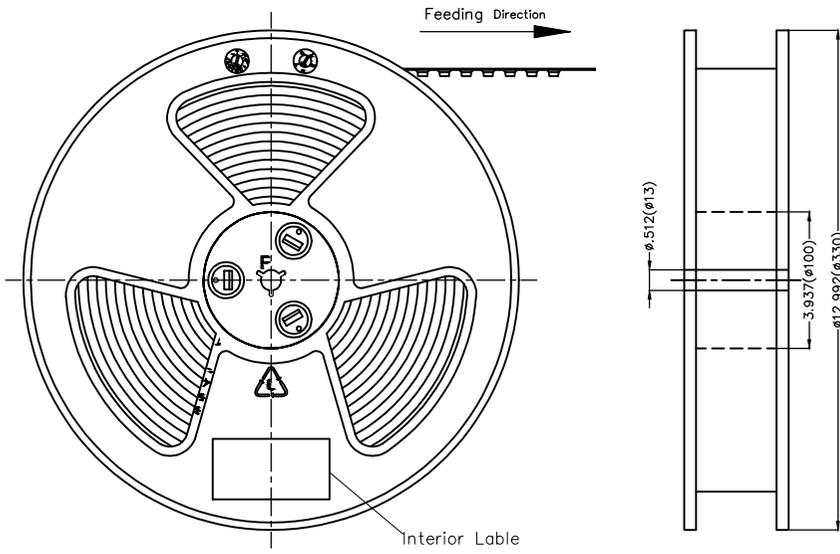
1 2 3 4 5 6 7 8

REV	LOCATIONS	DESCRIPTION	DATE	REVISER	APPD

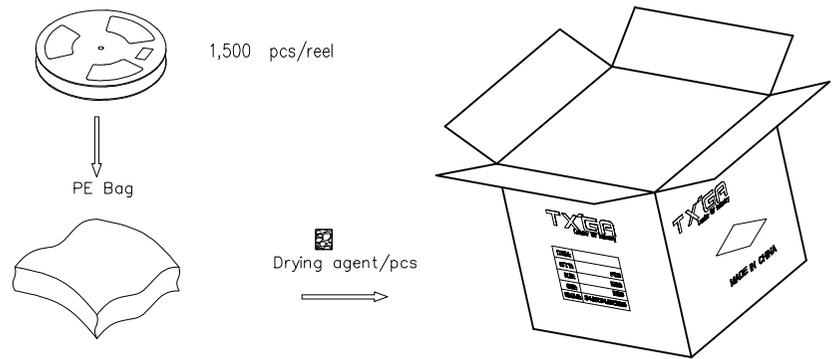
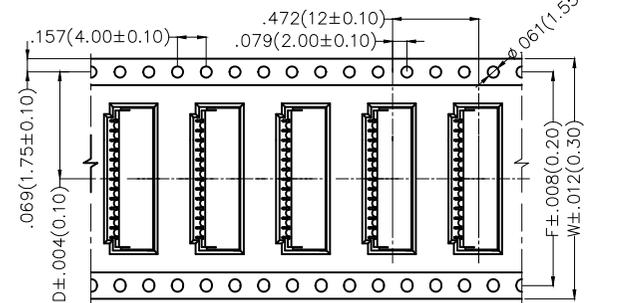
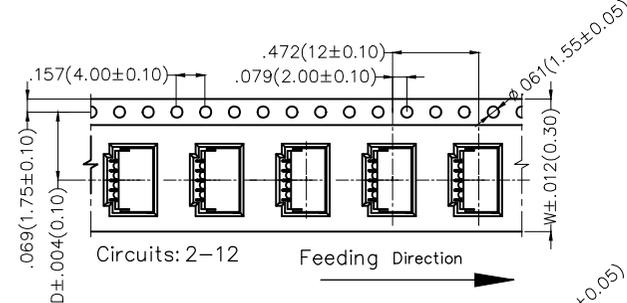
Note:

- 10 sprocket hole cumulative tolerance±0.2
- Carrier camber is within 1.0mm in 250mm
- Material: White Conductive polystyrene Alloy 100% recyclable
- All dimensions meet EIA-481-3 requirements
- Peel off force of cover tape&carrier tape: 20g~130g(0.2N~1.3N)
- Component load per 13" reel: 1,500 pcs

A
B
C
D
E
F



Circuits (n)	Dimensions(in/mm)		
	D	W	F
2~5	.295(7.50)	.630(16.00)	-
6~12	.453(11.50)	.945(24.00)	-
13~16	.561(14.25)	1.260(32.00)	1.122(28.50)
17~20	.797(20.25)	1.732(44.00)	1.594(40.50)



THIRD ANGLE PROJECTION	GENERAL TOLERANCES (UNLESS SPECIFIED)		APPROVE BY	DATE	PART NO.	ITEM NO.	 Leader Of Industry
	X.±.012(0.30)	X'.±5'	FRANK	28/JUN/13	FWF10001-SXXB24W5M	FWF10001	
DESIGN UNITS Inch (metric)	X.XX±.008(0.20)	.X'±2'	CHECKED BY	DATE	TITLE	REV 3 SHEET NO. 3/3	
SCALE 5:1	X.XX±.006(0.15)	.XX'±1'	JACOB	28/JUN/13	Wire to Board (Wafer) Pitch 1.0mm 90° Angle (SMT)	THIS DRAWING CONTAINS INFORMATION THAT IS PROPRIETARY TO TXGA INDUSTRIAL ELECTRONICS(S.Z)CO.,LTD AND SHOULD NOT BE USED WITHOUT WRITTEN PERMISSION	
SIZE A4	X.XXX±.004(0.10)	.XXX'±0.5'	DRAWN BY	DATE			
			CHERRY	28/JUN/13			